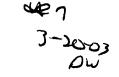
MAR 1 2 2003 B Docket No. p7291



## **PATENT**

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:

Bachrach, Yuval

Application No.: 09/471,200

Filed: 12/23/99

For: Physical Layer and Data Link...

**Assignee: Intel Corporation** 

Assistant Commissioner for Patents Washington, D.C. 20231

Examiner: Serrao, Ranodhi N.

Art Unit: 2189

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail with sufficient postage in an envelope addressed to the Assistant Commissioner of Patents, Washington, D.C. 20231

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## **RESPONSE A**

Request for Reconsideration under CFR§1.111

**Technology Center 2100** 

**Assistant Commissioner for Patents:** 

In response to the Office Action dated 10/8/2002, Applicant respectfully requests reconsideration of the above-identified patent application as discussed below.

## Remarks

Claims 1-15 are presently active.

In the Office Action dated 10/8/2002 ("Office Action"), claims 1, 3, 5, 7, 9, 10, 11, and 12 were rejected under 35 U.S.C. §102(b) as being anticipated by Engdahl et al., U.S. patent 5,493,571 ("Engdahl"); Claims 2, 4, 6, and 8 were rejected under 35 U.S.C. §103(a) as being unpatentable over Engdahl and further in view of Findlater et al., U.S. patent 6,385,208 ("Findlater"); and claims 13, 14, and 15 were rejected under 35 U.S.C.